

Features

- NPN Transistor:
 - BV_{CEO} > 100V
 - I_C = 3A Continuous Collector Current
 - I_{CM} = 8A Peak Pulse Current
 - R_{CE(sat)} = 90mΩ (Typ)
- PNP Transistor
 - BV_{CEO} > -100V
 - I_C = -3A Continuous Collector Current
 - I_{CM} = -8A Peak Pulse Current
 - R_{CE(sat)} = 110mΩ (Typ)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DXTC3C100PDQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI5060-8/SWP (Type UXD)
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Lead-Frame; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

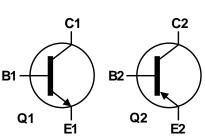
Applications

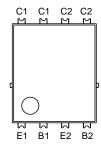
- Power Management
- Load Switches
- MOSFET and IGBT Gate Drivers





Bottom View





Internal Schematic

Top View Pin Configuration

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
DXTC3C100PDQ-13	Automotive	DXTC3C100PD	13	12	2,500

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

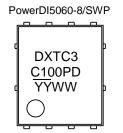
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



DXTC3 = Product Type Marking Code C100PD = Product Type Marking Code $\overline{YY}WW$ = Date Code Marking \overline{YY} = Last Digit of Year (ex: 21 = 2021) WW = Week Code (01 to 53)



NPN Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	100	V
Collector-Emitter Voltage	V _{CEO}	100	V
Emitter-Base Voltage	V _{EBO}	7	V
Base Current	Ι _Β	500	mA
Continuous Collector Current	lc	3	A
Peak Pulse Collector Current	I _{CM}	8	A

PNP Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-100	V
Collector-Emitter Voltage	V _{CEO}	-100	V
Emitter-Base Voltage	V _{EBO}	-7	V
Base Current	IB	-500	mA
Continuous Collector Current	Ic	-3	A
Peak Pulse Collector Current	I _{CM}	-8	A

Thermal Characteristics (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Power Dissipation(Notes 5, 7)Linear Derating Factor(Notes 6, 7)		D	1.47	W	
		PD	11.76	mW/°C	
Thermal Desistance, Junction to Ambient	(Notes 5, 7)	P	85	°C/W	
Thermal Resistance, Junction to Ambient	(Notes 6, 7)	R _{θJA}	37		
Thermal Resistance, Junction to Lead (Note 8)		$R_{\theta JL}$	5.7		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge – Charged Device Model	ESD CDM	1000	V	C3

Notes: 5. For a device mounted with the collector lead on 25mm x 25mm 1oz copper that is on single-sided 1.6mm FR4 PCB; device with one active die is measured under still air conditions whilst operating in a steady-state.

6. Same as Note 5, except the device is measured at t \leq 5 sec.

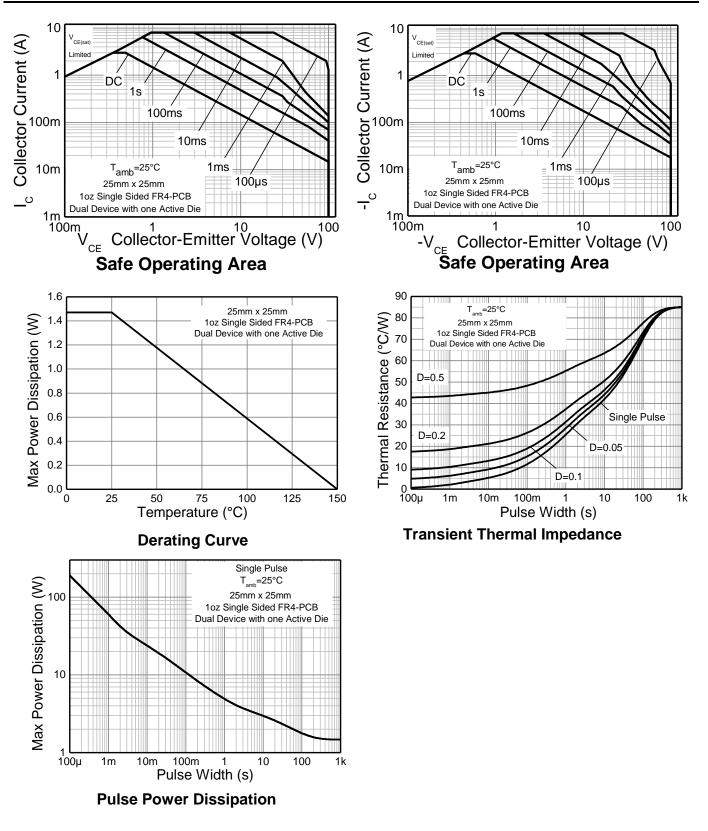
7. For a dual device with one active die.

8. Thermal resistance from junction to solder-point (at the end of the collector lead).

9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





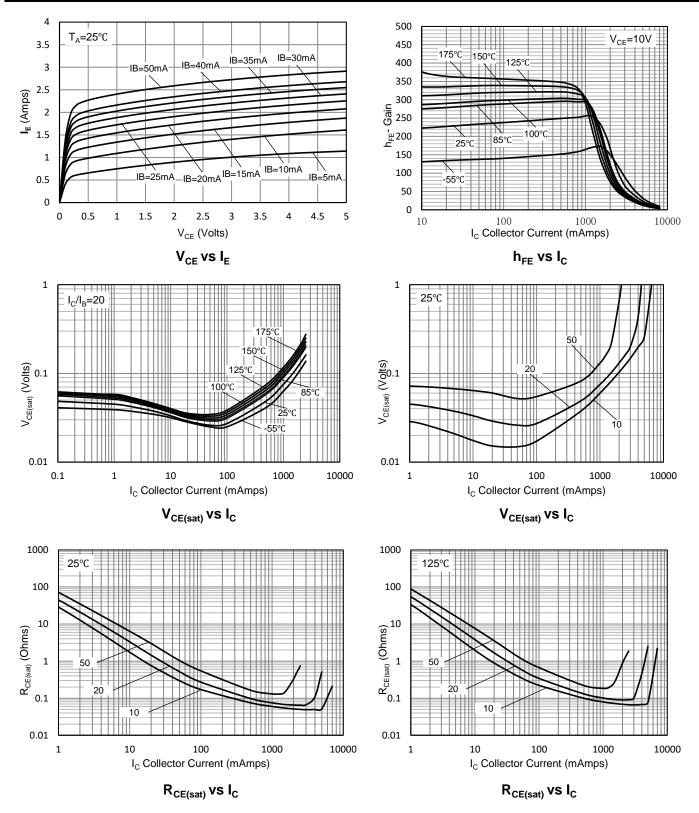
NPN Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS			•		•	•
Collector-Base Breakdown Voltage	BV _{CBO}	100	—	—	V	$I_{\rm C} = 100 \mu A$
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	100	—	—	V	$I_{\rm C} = 10 {\rm mA}$
Emitter-Base Breakdown Voltage	BV _{EBO}	7	—	—	V	I _E = 100μA
Collector-Base Cutoff Current		_	—	100	nA	$V_{CB} = 80V$
Collector-Base Cutori Current	I _{CBO}	_	—	50	μA	V _{CB} = 80V @Tj = 150°C
Emitter Cutoff Current	I _{EBO}	_	—	100	nA	$V_{EB} = 7V$
Collector-Emitter Cutoff Current	ICES	_	—	100	nA	$V_{CES} = 80V$
ON CHARACTERISTICS (Note 10)						
		150	250	—		$I_{C} = 500 \text{mA}, V_{CE} = 10 \text{V}$
DC Current Gain	h	80	250	—		$I_{C} = 1A, V_{CE} = 10V$
	h _{FE}	20	100	—	_	$I_{C} = 2A, V_{CE} = 10V$
		10	40	—		$I_{C} = 3A, V_{CE} = 10V$
Collector-Emitter Saturation Voltage		_	90	150	mV	$I_{C} = 1A, I_{B} = 50mA$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	—	225	330	mV	$I_{C} = 3A, I_{B} = 300mA$
Collector-Emitter Saturation Resistance	R _{CE(sat)}	—	90	150	mΩ	$I_{C} = 1A, I_{B} = 50mA$
Base-Emitter Saturation Voltage	M	—	0.86	1.0	V	$I_{C} = 1A, I_{B} = 50mA$
Dase-Emilier Saturation Voltage	V _{BE(sat)}	—	1.0	1.2	v	$I_{C} = 2A, I_{B} = 200mA$
Base-Emitter Turn-On Voltage	V _{BE(on)}	—	0.67	0.85	V	$I_C=0.1A,V_{CE}=2V$
SMALL SIGNAL CHARACTERISTICS			_	-	_	
Current Gain-Bandwidth Product	f⊤		130	—	MHz	$V_{CE} = 10V, I_C = 100mA, f = 100MHz$
Output Capacitance	Cobo	—	11	_	pF	$V_{CB} = 10V, f = 1MHz$
Delay Time	t _d	—	40	—	ns	
Rise Time	tr	—	20	—	ns	
Turn-On Time	t _{on}	_	60		ns	V _{CC} = 12.5V, I _C = 1A
Storage Time	ts	_	620	_	ns	$I_{B1} = -I_{B2} = 0.05A$
Fall Time	t _f	—	40	_	ns	
Turn-Off Time	t _{off}	_	660	_	ns]

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

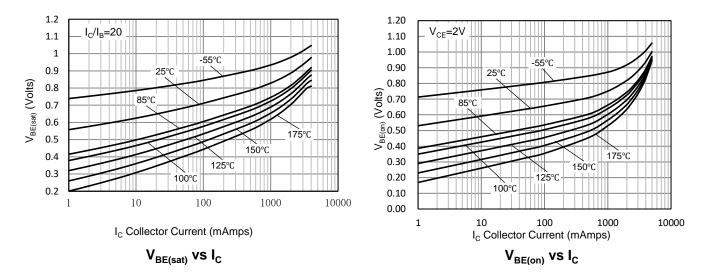


NPN Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)





NPN Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.) (continued)





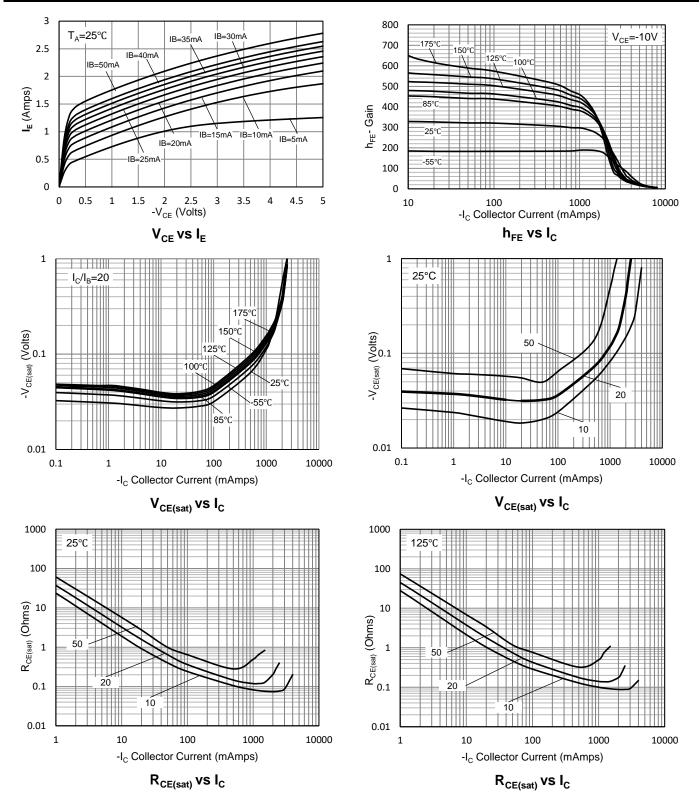
PNP Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS			•		•	•
Collector-Base Breakdown Voltage	BV _{CBO}	-100	—	—	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-100	—	_	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	_	_	V	I _E = -100μA
Collector-Base Cutoff Current		_	_	-100	nA	V _{CB} = -80V
Collector-Base Cutori Current	I _{CBO}	_	_	-50	μA	V _{CB} = -80V @Tj = 150°C
Emitter Cutoff Current	I _{EBO}	_	_	-100	nA	V _{EB} = -7V
Collector-Emitter Cutoff Current	ICES	_	_	-100	nA	V _{CES} = -80V
ON CHARACTERISTICS (Note 10)			_	-		
		170	305	—		$I_{C} = -500 \text{mA}, V_{CE} = -10 \text{V}$
DC Current Gain	h	160	275	—		$I_{C} = -1A, V_{CE} = -10V$
	h _{FE}	45	90	—		$I_{C} = -2A, V_{CE} = -10V$
		10	20	—		$I_{C} = -3A, V_{CE} = -10V$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	-70	-110	mV	$I_{C} = -0.5A, I_{B} = -50mA$
		_	-220	-325		$I_{C} = -2A, I_{B} = -200mA$
Collector-Emitter Saturation Resistance	R _{CE(sat)}	_	110	180	mΩ	$I_{C} = -2A, I_{B} = -200mA$
Base-Emitter Saturation Voltage	Varia	_	-0.91	-1	V	$I_{C} = -1A, I_{B} = -50mA$
Dase-Limiter Saturation Voltage	V _{BE(sat)}	_	-1.02	-1.2	v	$I_{C} = -2A, I_{B} = -200mA$
Base-Emitter Turn-On Voltage	V _{BE(on)}		-0.68	-0.9	V	$I_{C} = -0.1A, V_{CE} = -2V$
SMALL SIGNAL CHARACTERISTICS						
Current Gain-Bandwidth Product	f⊤		100	—	MHz	$V_{CE} = -10V, I_C = -100mA, f = 100MHz$
Output Capacitance	Cobo		30	—	pF	$V_{CB} = -10V$, f = -1MHz
Delay Time	t _d		30	—	ns	
Rise Time	tr	—	30	—	ns	
Turn-On Time	t _{on}		60	—	ns	V _{CC} = -12.5V, I _C = -1A
Storage Time	ts	_	660	—	ns	$I_{B1} = -I_{B2} = -50 \text{mA}$
Fall Time	t _f		50	_	ns]
Turn-Off Time	t _{off}		710	_	ns]

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

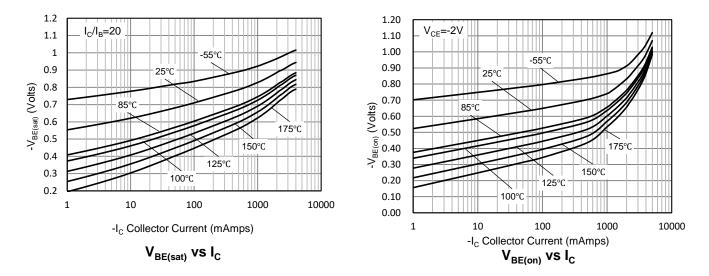


PNP Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)





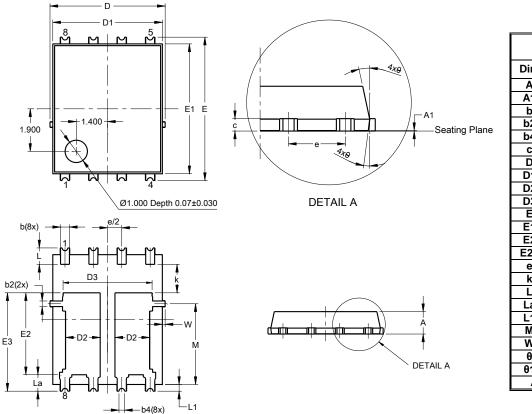
PNP Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.) (continued)





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

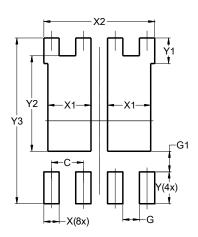


PowerDI5060-8/SWP (Type UXD) Dim Min Max Тур 0.90 1.10 1.00 Α 0.00 A1 0.05 b 0.30 0.50 0.41 b2 0.20 0.35 0.25 b4 0.25REF С 0.230 0.330 0.277 5.15 BS0 D D1 4.70 5.10 4.90 D2 1.55 1.46 1.66 D3 3.78 4.18 3.98 Ε 6.40 BSC E1 6.00 5.60 5.80 E2 3.46 3.86 3.66 E2a 4.195 4.595 4.395 1.27BSC е 1.05 k L 0.635 0.835 0.735 0.835 La 0.635 0.735 0.400 L1 0.200 0.300 Μ 3.205 4.005 3.605 W 0.025 0.225 0.125 θ 10° 11° 12° θ1 6° 8° 7° All Dimensions in mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	1.720
X2	4.420
Ŷ	1.270
Y1	1.020
Y2	3.810
Y3	6.610

PowerDI5060-8/SWP (Type UXD)



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